BYV116 series

GENERAL DESCRIPTION

Dual nickel silicide schottky barrier rectifier diodes in a plastic envelope featuring low forward voltage drop and absence of stored charge. These devices can withstand reverse voltage transients and have guaranteed reverse surge capability. The devices are intended for use in switched mode power supplies and d.c. to d.c. converters, or as or-ing diodes in fault tolerant power supply systems.

PINNING - TO220AB

PINDESCRIPTION1anode 1 (a)2cathode (k)3anode 2 (a)tabcathode (k)

QUICK REFERENCE DATA

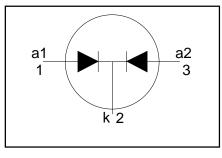
SYMBOL	PARAMETER	MAX.	MAX.	UNIT
V _{RRM} V _F I _{O(AV)}	BYV116- Repetitive peak reverse voltage Forward voltage Average output current (both diodes conducting)	20 20 0.54 10	25 25 0.54 10	V V A

PIN CONFIGURATION

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SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
V _{RRM} V _{RWM} V _R	Repetitive peak reverse voltage Crest working reverse voltage Continuous reverse voltage	T _{mb} ≤ 117 °C		-20 20 20 20	-25 25 25 25	V V V
I _{O(AV)}	Average output current (both diodes conducting)	square wave; δ = 0.5; T _{mb} \leq 119 °C	-	1	0	A
I _{O(RMS)}	RMS output current (both diodes conducting)		-	1	4	A
I _{FRM}	Repetitive peak forward current per diode	t = 25 μs; δ = 0.5; T _{mb} ≤ 119 °C	-	1	0	A
I _{FSM}	Non-repetitive peak forward current, per diode	t = 10 ms t = 8.3 ms sinusoidal $T_j = 125$ °C prior to surge; with reapplied $V_{RRM(max)}$	-		0 5	AA
l ² t	I ² t for fusing	t = 10 ms	-	12	2.5	A ² s
RRM	Repetitive peak reverse current per diode		-	1		A
RSM	Non-repetitive peak reverse current per diode	t _p = 100 μs	-	1	l	A
T _{stg} T _j	Storage temperature Operating junction temperature		-65 -		75 50	°C °C

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THERMAL RESISTANCES

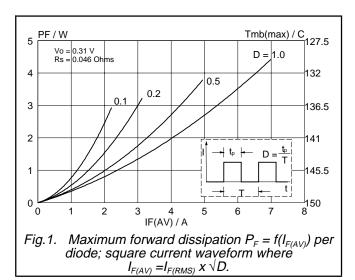
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-mb} R _{th j-a}	mounting base	per diode both diodes in free air	-	- - 60	4.5 4.0 -	K/W K/W K/W

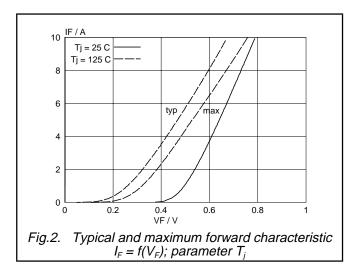
STATIC CHARACTERISTICS

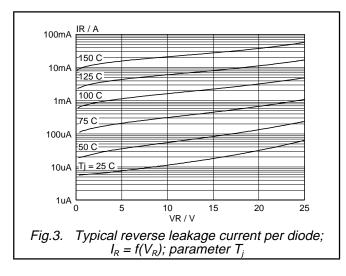
 $T_j = 25$ °C unless otherwise stated

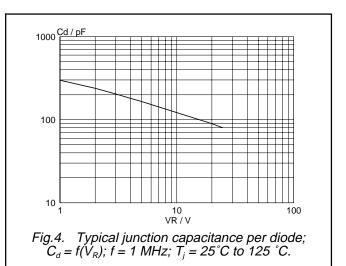
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage (per diode)	I _F = 5 A; T _i = 125°C I _F = 10 A; T _i = 125°C	-	0.47	0.54	V
		I _F = 10 A; Τ _i = 125°C	-	0.66	0.77	V
		$I_F = 5 A$	-	0.58	0.64	V
I _R	Reverse current (per diode)	$\dot{V}_{R} = V_{RRM}$	-	0.05	3.0	mA
		$V_{R} = V_{RRM}$; T _i = 100 °C	-	5	10	mA
C _d	Junction capacitance (per diode)	$V_{R}^{K} = V_{RRM}^{KRM}$; T _j = 100 °C f = 1MHz; V _R = 5V; T _j = 25 °C to 125 °C	-	160	-	pF

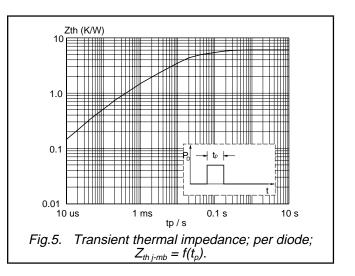
BYV116 series







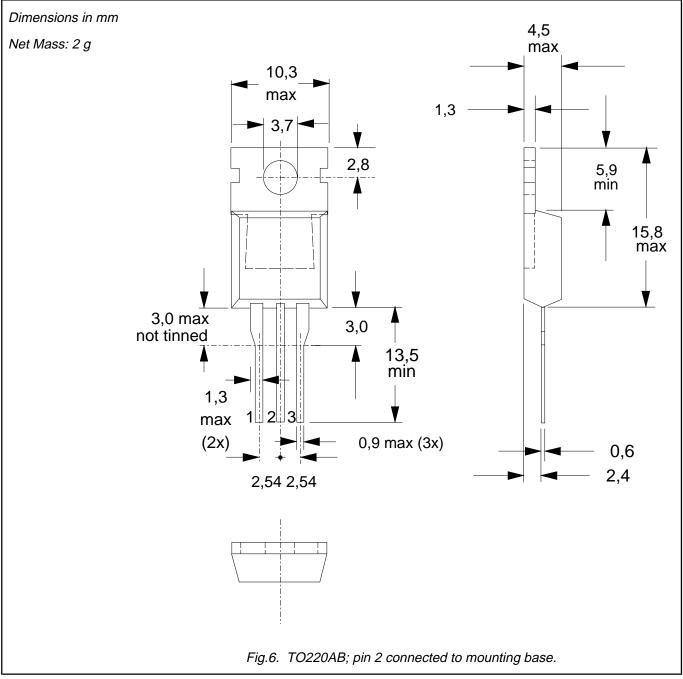




Product specification

BYV116 series

MECHANICAL DATA



Notes 1. Refer to mounting instructions for TO220 envelopes. 2. Epoxy meets UL94 V0 at 1/8".

BYV116 series

DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				

Application information

Where application information is given, it is advisory and does not form part of the specification.

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